



Data Sheet Of Colored Through Hole 3mm LEDs With Long Legs And Flange

客户名称		Product Name	3mm colorful F3 LED
客户物料编号		Model No	LR22122601
			LY22122601
			LO22122702
			LB22122601
			LG22122601
			LP22122702
产品规格		版本号	A0

供应商确认			
拟定	审核	批准	日期
何欢	文思	罗泽永	2023-3-23

客户确认			
采购	工程	品管	日期

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■ Applications

Interior automotive lighting (dashboard backlight etc...)

Optical indicators

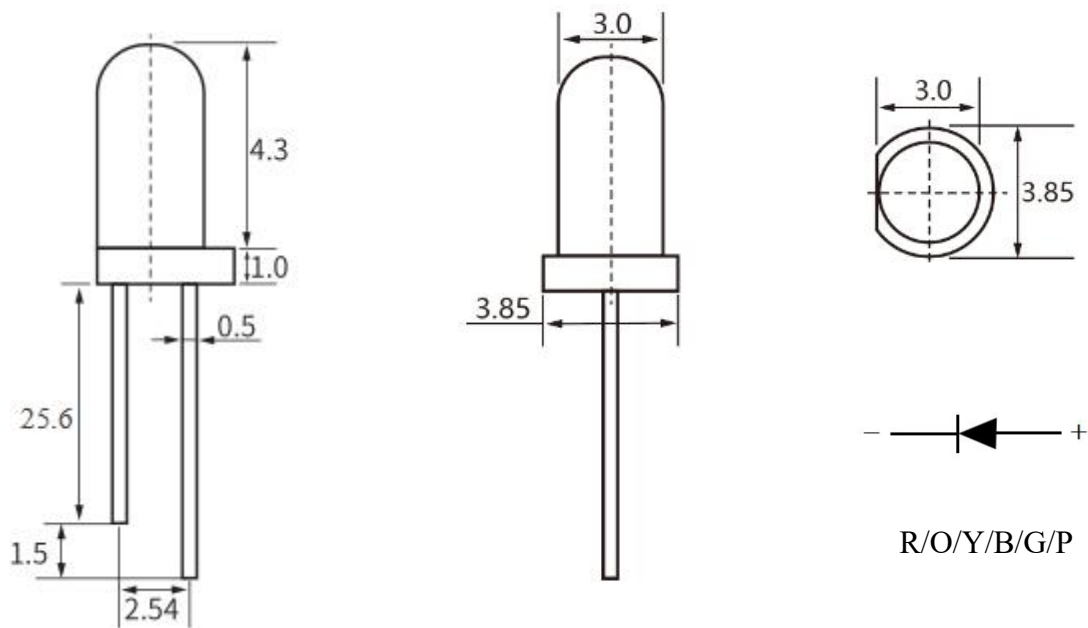
Communication Products

Backlighting

Flash

Toy

■ Package Dimensions



Notes:

1. All dimensions are in millimeters.
2. Tolerance is $\pm 0.20\text{mm}$ unless otherwise noted.
3. Protruded resin under flange is 1.0mm max
4. Lead spacing is measured where the leads emerge from the package.
5. Caution in ESD:

Static Electricity and surge damages the LED. It is recommending to use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.

■ Absolute Maximum Ratings (Ta = 25℃)

Parameter	Symbol	Colour	Value	Unit
Power Dissipation	Pd	Red/Yellow/Orange	72	mW
		Blue/Green/Purple	102	
Peak pulsing current (1/8 duty f=1KHz)	Ifp	Red/Yellow/Orange/Blue/Green/Purple	60	mA
Forward Current	If	Red/Yellow/Orange/Blue/Green/Purple	20	mA
Operating Temperature Range	Top	Red/Yellow/Orange/Blue/Green/Purple	-25 ~ +80	℃
Storage Temperature Range	Tstg	Red/Yellow/Orange/Blue/Green/Purple	-30 ~ +85	℃
Junction Temperature	Tj	Red/Yellow/Orange/Blue/Green/Purple	115	℃
Electrostatic Discharge	ESD	Red/Yellow/Orange/Blue/Green/Purple	2000(HBM)	V
Lead Soldering Temperature	260℃ for 3 Seconds			

■ Typical Electrical & Optical Characteristics (Ta = 25℃)

Parameter	Colour	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Forward Voltage	R/Y/O	VF	1.8	2.0	2.2	V	IF=20mA
	B/G/P		2.8	3.0	3.2		
Viewing Angle	R/Y/O/B/G/P	2θ1/2	--	30	--	Deg	IF=20mA
Reverse Current	R/Y/O/B/G/P	Ir	--	--	10	μA	Vr=5V

■ Dominant Wavelength Guide (Ta = 25℃)

Colour	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Red	λ _D	620	625	630	nm	IF=20mA
Yellow	λ _D	588	592	594	nm	IF=20mA
Orange	λ _D	600	--	615	nm	IF=20mA
Blue	λ _D	455	465	475	nm	IF=20mA
Green	λ _D	515	520	525	nm	IF=20mA
Purple	λ _P	360	--	420	nm	IF=20mA

■ Luminous Intensity/Light Intensity Guide(Ta = 25℃)

Colour	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Red	IV	500	900	1200	mcd	IF=20mA
Yellow	IV	300	500	700	mcd	IF=20mA
Orange	IV	300	--	1200	mcd	IF=20mA
Blue	IV	600	800	1000	mcd	IF=20mA
Green	IV	2000	5000	8000	mcd	IF=20mA
Purple	IV	100	--	400	mcd	IF=20mA

■ Notes:

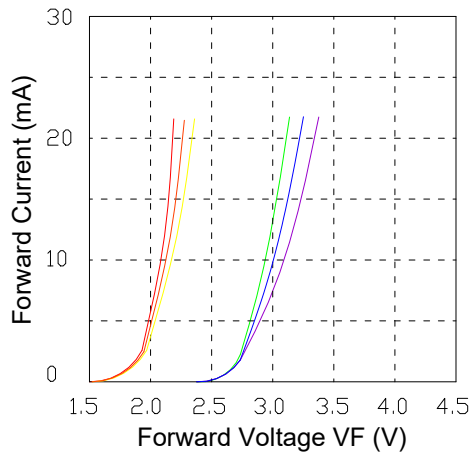
1. Tolerance of measurement of luminous intensity : ±15%
2. Tolerance of measurement of dominant wavelength : ±1.0nm
3. Tolerance of measurement of forward voltage : ±0.1V



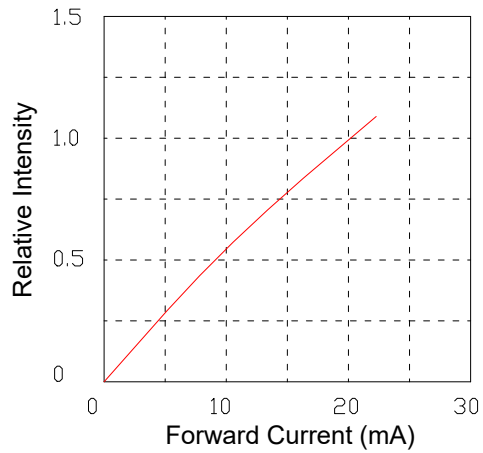
■ Typical Electrical/ Optical Characteristics Curves

(Ta=25°C Unless Otherwise Noted)

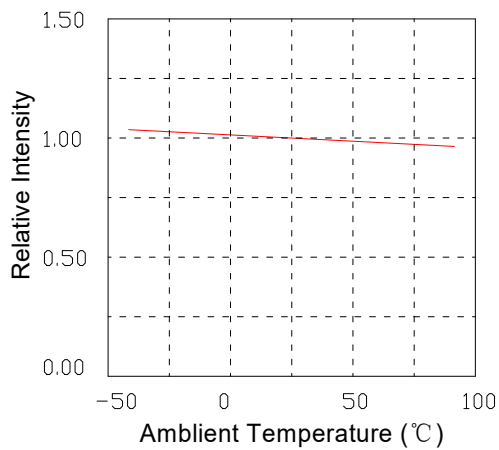
Forward Voltage VS. Forward Current (Ta=25°C)



Relative Intensity VS. Forward Current (Ta=25°C)

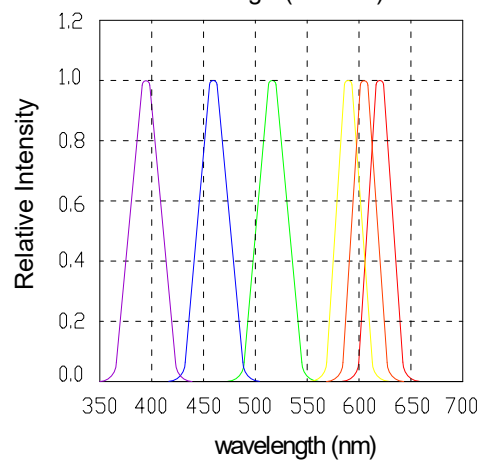


Relative Intensity VS. Ambient Temperature



Spectral Distribution

Relative Intensity VS. Wavelength (Ta=25°C)



Derating

Ambient Temperature VS. Maximum Forward Current

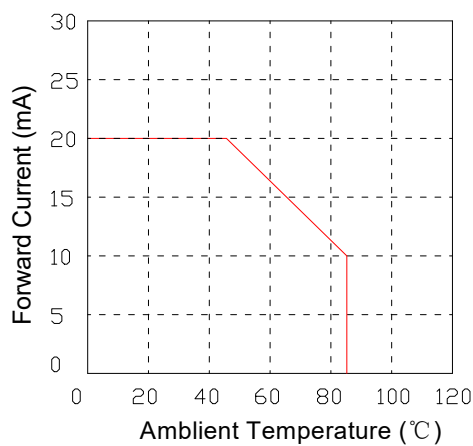
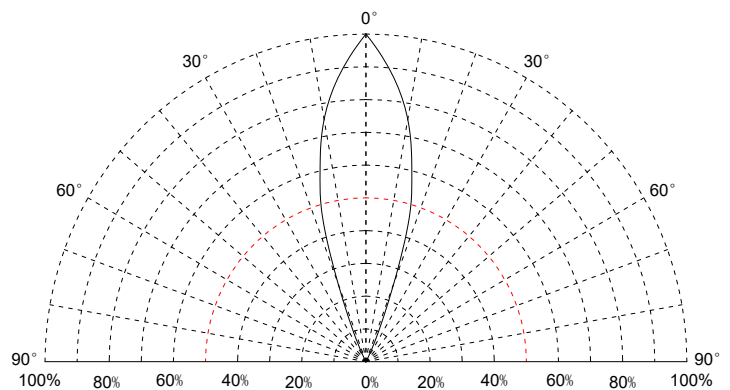


Diagram characteristics of radiation



Note: The data shown above are typical curves. Every LED component may have some variations of characteristics.

■ Test Items and Conditions:

No.	Test Item 测试项目	TJ. Standard 腾杰参照标准	Test Conditions 测试条件	Note 频次	Number of Damaged 允许破坏数
01	Temperature Cycle 高低温循环	JIS C 7021 (1977)A-4	-25°C 30min ↑↓5min 80°C 30min	100 cycle	0/22
02	Thermal Shock 冷热冲击测试	MIL-SLD-107D	-25°C 15min ↑↓5min 80°C 15min	50 cycle	0/22
03	High Humidity Heat Cycle 高湿度热循环	JIS C 7021 (1977)A-5	30°C <=> 65°C 90%RH 24hrs/1cycle	10 cycle	0/22
04	High Temperature Storage 高温存储	JIS C 7021 (1977)B-10	T _a =80°C	1000 hrs	0/22
05	Humidity Heat Storage 高温高湿存储	JIS C 7021 (1977)B-11	T _a =60°C RH=90%	1000 hrs	0/22
06	Low Temperature Storage 低温贮藏	JIS C 7021 (1977)B-12	T _a =-30°C	1000 hrs	0/22
07	Life Test 常温寿命测试	JIS C 7035 (1985)	T _a =25°C I _F =20mA	1000 hrs	0/22
08	High Humidity Heat Life Test 高温高湿寿命测试	ⓘ	60°C RH=90% I _F =20mA	500 hrs	0/22
09	Low Temperature Life Test 低温寿命测试	ⓘ	T _a =-25°C I _F =20mA	1000 hrs	0/22

ⓘ Refer to reliability test standard specification for in this line. 请参考可靠性测试标准规范

■ Criteria For Judging Damage:

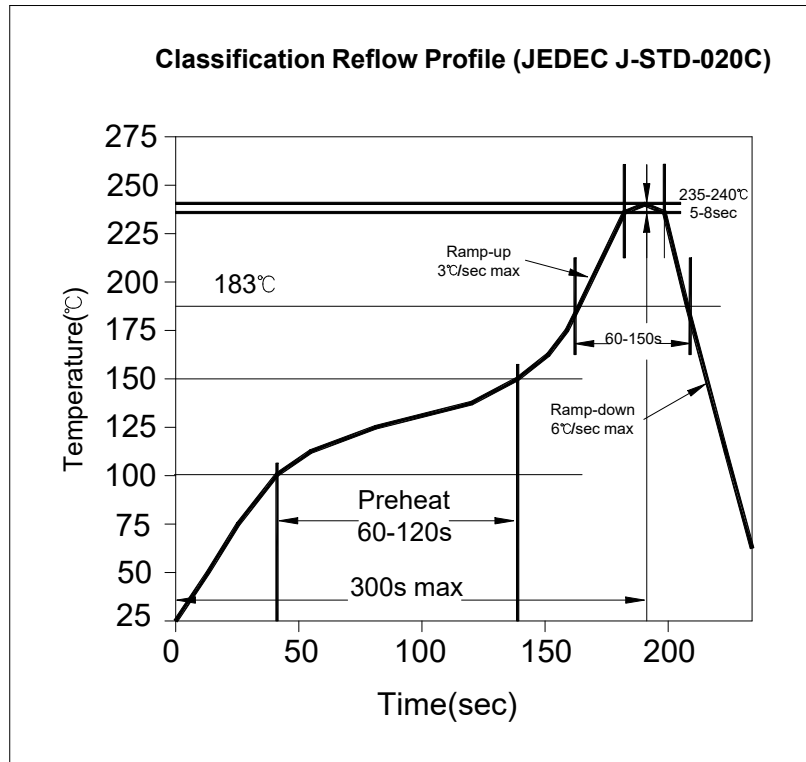
No.	Test Item 测试项目	Symbol 符号	Test Conditions 测试条件	Decision criteria 判定标准
01	正向电压 Forward Voltage	V _F	I _F =I _{FT}	初始值±10% Initial Data±10%
02	反向电流 Reverse Current	I _R	V _R =5V	I _R ≤ 10μA
03	光强 Luminous Intensity	I _V	I _F =I _{FT}	平均 I _V 衰减 ≤ 30%，单个平均 I _V 衰减 ≤ 50% Average I _V degradation ≤ 30% Single LED I _V degradation ≤ 50%
04	耐焊接热 Resistance to Soldering Heat	--	--	材料无内部裂痕、无材料间爆裂、剥离、无死灯 Material without internal cracks, no material between stripped, no deaded light.

*The technical information shown in the data sheets are limited to the typical characteristics and circuit examples of the referenced products. It does not constitute the warranting of industrial property nor the granting of any license.

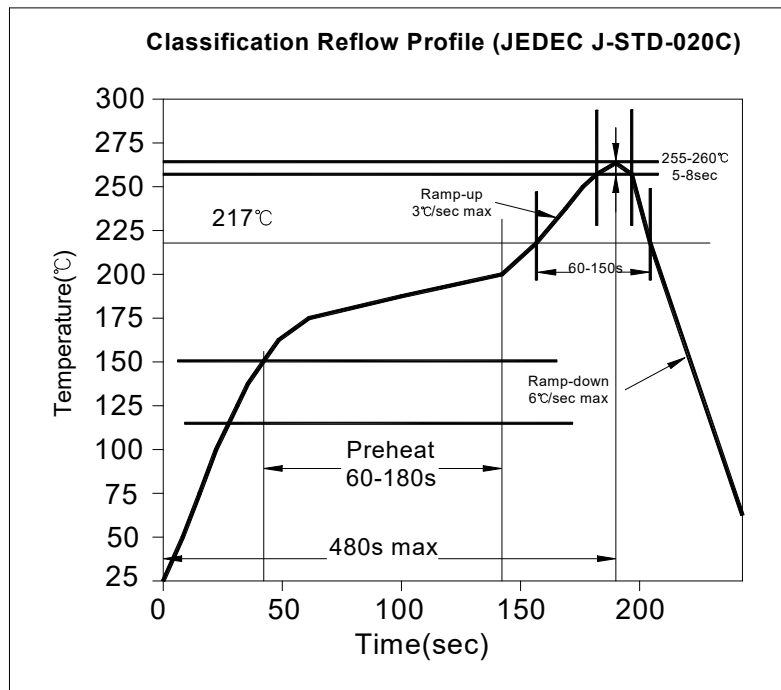
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■ Soldering heat reliability:
Lead Solder



Lead-Free Solder





■ **Precaution of Application** 应用预防措施

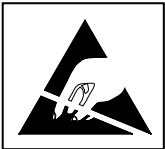
1: Circuit layout

Due to the forward voltage of LED will vary with temperature and its driving current, the current- limited protective circuit should be considered in the LED circuit design.

When LEDs are arrayed as parallel circuit, different inherent resistance of LED will cause unbalance current. The unbalanced driving current which exists in every parallel circuit may make LED to be driven at different power. Therefore, the LED driven at higher power may be damaged by over driving current, and the LED driven at lower power may be dimmer than the others.

To solve this situation, a suitable resistor is recommended to put in series with each LED circuit. The resistor will limit and balance the driving current which flows through every parallel circuits.

2: Electric Static Discharge (ESD) Protection



All kinds of LED materials, such as GaP, AlGaAs, AlInGaP, GaN, or InGaN chips, are STATIC SENSITIVE device. ESD protection or surge voltages shall be considered and taken care in the initial design stage, and whole production process.

The following protection is recommended:

- (1) A wrist band or an anti-electrostatic glove shall be used when handling the LEDs
- (2) All devices, equipment and machinery must be properly grounded

If LED is damaged by ESD or surge voltage, damaged LED may show some unusual characteristics. It may appear leakage current, and LED does not emit at low current.

And when using microscope to inspect damaged LED chip at low driving current, it may have some black dots within the emitting area.

3: Pick and Place

The following items should be paid attention in assembly process:

- (1) It should be avoided to load stress on the resin during pick and place process, especially at high temperature.
- (2) Avoid rubbing or scraping the resin by any object, and avoid leaving fingerprints on the lens.
- (3) Electric-static may cause damage to the component. Please confirm that the equipment is grounding well.

4: Storage



It's recommended to store the products in the following conditions:

- (1) Shelf life in sealed bag: 6 months at $T_A < 40^{\circ}\text{C}$ and $\text{Hum.} < 30\%\text{RH}$. (Base on aluminum laminated moisture barrier bag.)
- (2) After the package bag is opened and kept in the following environment, the LED products should be used completely as soon as possible:

Humidity (Hum.) : 60%RH Max.

Temperature (T_A) : $5^{\circ}\text{C} \sim 30^{\circ}\text{C}$ ($41^{\circ}\text{F} \sim 86^{\circ}\text{F}$)

Assembly duration: within 10 today, after bag is opened.

If the some of LED are not used, they need to be kept at $\text{Hum.} \leq 30\%\text{RH}$ in zip-locked sealed bags.

Please avoid rapid transitions in ambient temperature, especially in high humidity environment where condensation can occur.

5: Cleaning

An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended to clean the LED, after soldering process, if cleaning is necessary. Before cleaning, a pre-test should be done to confirm whether any damage to the LEDs will occur.

It is not recommended to use unspecified chemical liquids as cleaning material for cleaning the LED. It' s also not recommended to use ultrasonic power to clean the LED device. The chemical and ultrasonic power could harm the LED devices.

6: Manual Soldering and Rework

The manual soldering process is not recommended for quality consideration. When it is absolutely necessary, the LEDs may be mounted in this fashion but the user will assume responsibility for any problems.

The the following conditions are recommended :

- (1) Soldering material : SN60 (60% tin and 40% lead) solder or solder with silver content is recommended.
- (2) Temperature of the iron : lower than 300°C
- (3) Soldering time : maximum 3 seconds
- (4) Operation cautions:



- Please avoid overheating of LED component in any process. Overheating may damage the LED package.
- Please don't place any stress on the lens of LED, especially at high temperature

7: Application

- (1) The strong light from LEDs may injure human eyes. Precautions should be taken to prevent looking directly at the LEDs with unaided eyes.
- (2) In order to get maximum light output during the duration of LED's long life, designer should consider how to make excellent thermal dissipation when making the whole system design. It's recommended to avoid intense heat generation and to operate within the maximum ratings given in this approval sheets.
- (3) Every piece of LED will be sorted and LEDs with the same binning grade will be taped into the same reel or put into the same bag. It is recommended to use the same bin-grade LED to assembly the unit module. This will ensure the LED unit module with good uniformity of brightness, hue, and so on.